## 2SB562

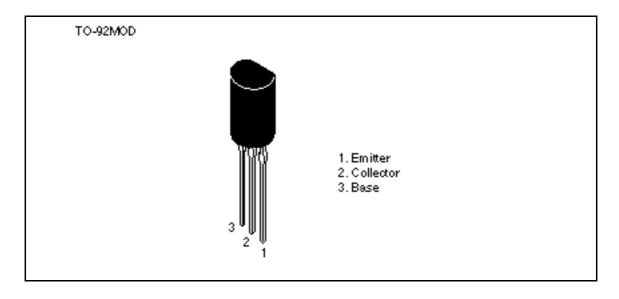
## Silicon PNP Epitaxial

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## Application

- Low frequency power amplifier
- Complementary pair with 2SD468

#### Outline





## 2SB562

#### Absolute Maximum Ratings ( $Ta = 25^{\circ}C$ )

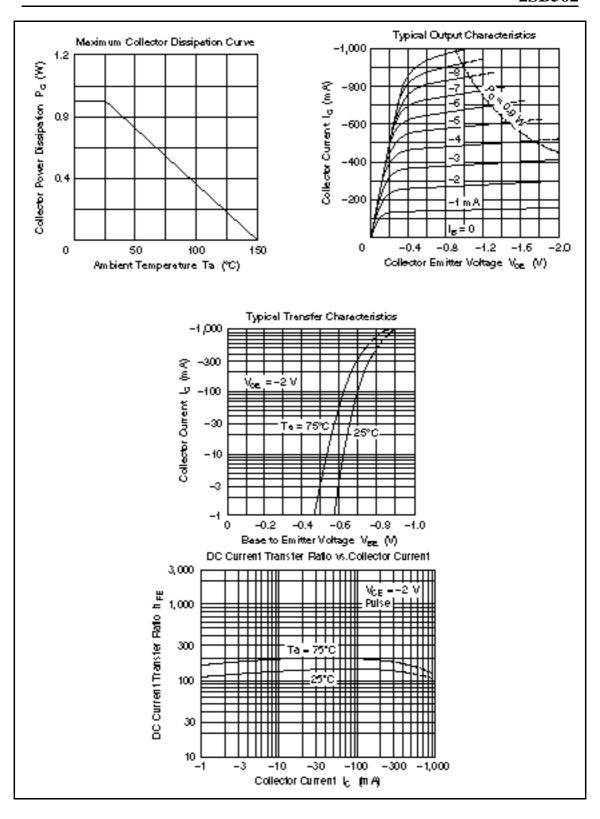
Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	-25	V
Collector to emitter voltage	V <sub>CEO</sub>	-20	V
Emitter to base voltage	$V_{EBO}$	<b>-</b> 5	V
Collector current	I <sub>c</sub>	-1.0	A
Collector peak current	i <sub>C(peak)</sub>	-1.5	A
Collector power dissipation	P <sub>c</sub>	0.9	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

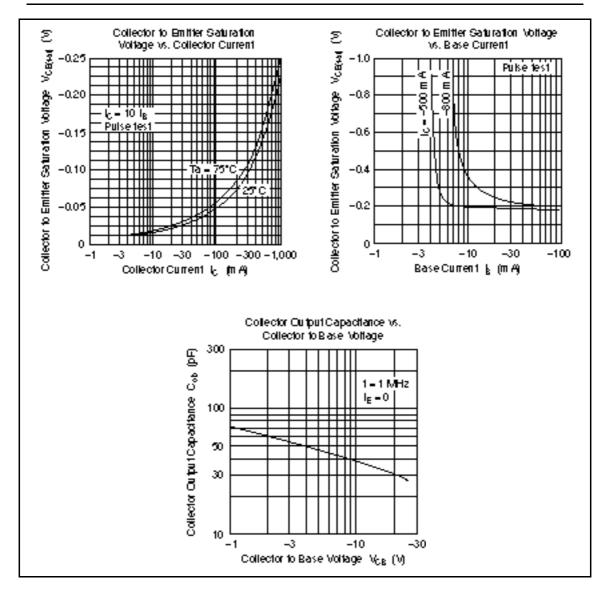
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\text{(BR)CBO}}$	-25	_	_	V	$I_{\rm C} = -10 \ \mu A, \ I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-20	_	_	V	$I_C = -1 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	<b>-</b> 5	_	_	V	$I_{E} = -10 \ \mu A, \ I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	-1.0	μΑ	$V_{CB} = -20 \text{ V}, I_{E} = 0$
DC current transfer ratio	h <sub>FE</sub> *1	85	_	240		$V_{CE} = -2 \text{ V},$ $I_{C} = -0.5 \text{ A (Pulse test)}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	-0.2	-0.5	V	$I_{c} = -0.8 \text{ A},$ $I_{B} = -0.08 \text{ A (Pulse test)}$
Base to emitter voltage	$V_{\text{BE}}$	_	-0.8	-1.0	V	$V_{CE} = -2 \text{ V},$ $I_{C} = -0.5 \text{ A (Pulse test)}$
Gain bandwidth product	f <sub>T</sub>	_	350	_	MHz	$V_{CE} = -2 \text{ V},$ $I_{C} = -0.5 \text{ A (Pulse test)}$
Collector output capacitance	Cob	_	38	_	pF	$V_{CB} = -10 \text{ V}, I_{E} = 0$ f = 1 MHz

Note: 1. The 2SB562 is grouped by h<sub>FE</sub> as follows.

В	С
85 to 170	120 to 240



#### 2SB562



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